

GET (3519TT) announced Mass Production for Wafer-Slicing in China with Slicing Capacity Plan expands to 1GW in the 4th Quarter of 2010

Dear investors and analysts:

Please be informed that Green Energy Technology (GET, 3519.TT) announced mass production for wafer-slicing in China Shandong, with further slicing expansion plan to reach 1GW in the 4th quarter of 2010.

GET subsidiary in China, Ultra Energy (Weifang) Technology, is planning to focus on wafer slicing production starting from 50MW annual capacity. Along with ingot growing capacity plan announced, GET aims to expand slicing capacity to 1GW by end of 2010 as well.

GET Annual Capacity Plan

GET Annual Capacity	Q4, 2009	Q1, 2010	Q2, 2010	Q4,2010
Ingot growing	360MW	410MW	600MW	1GW
Wafer slicing	300MW	350MW	500MW	1GW

Thank you for your attention.